

# TECHNICAL MANUAL

## LSI53C120 Ultra SCSI Bus Expander

**August 2001**

*Version 1.0*

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# Preface

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This book is the primary reference and technical manual for the LSI53C120 Ultra SCSI Bus Expander. It contains a complete functional description and complete physical and electrical specifications for the LSI53C120 Ultra SCSI Bus Expander chip, which supports single-ended to single-end SCSI bus expansion (Extender) or single-ended to differential SCSI bus conversion (Converter).

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## Audience

This manual assumes some prior knowledge of current and proposed SCSI standards. For background information, please contact:

### **ANSI**

11 West 42nd Street  
New York, NY 10036  
(212) 642-4900

Ask for document number X3.131-1994 (SCSI-2) (SCSI-3)

### **Global Engineering Documents**

15 Inverness Way East  
Englewood, CO 80112  
(800) 854-7179 or (303) 792-2181 (outside U.S.)

Ask for document number X3.131-1994 (SCSI-2) or X3.253 (SCSI-3 Parallel Interface)

### **ENDL Publications**

14426 Black Walnut Court  
Saratoga, CA 95070  
(408) 867-6642

Document names: SCSI Bench Reference, SCSI Encyclopedia

### **Prentice Hall**

Englewood Cliffs, NJ 07632

(201) 767-5937

Ask for document number ISBN 0-13-796855-8, SCSI: Understanding the Small Computer System Interface

### LSI Logic World Wide Web

<http://www.lsillogic.com>

(See EPI (Enhanced Parallel Interface) Specification for expander configurations)

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## Revision Record

Revision	Date	Remarks
1.0	8/01	All product name changes from a SYM to an LSI prefix. Updated figure references throughout book. Updated wiring diagram in Appendix A.

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## Organization

This document has the following chapters and appendixes:

- **Chapter 1, Introduction**, provides general information about the LSI53C120 Ultra SCSI Bus Expander.
- **Chapter 2, Functional Description**, provides information about the interface signal descriptions.
- **Chapter 3, Specifications**, describes the LSI53C120 as a 128-pin PQFP. It also provides minimum and maximum values for the electrical characteristics of this expander/converter.
- **Appendix A, Differential Wiring Diagram**, illustrates the LSI53C120 wiring diagram for Ultra SCSI operation.
- **Appendix B, Glossary**, provides definitions for key terms used in this manual.

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## Related Publication

*LSI53C141 SCSI Bus Expander, Version 2.1*, LSI Logic Corporation, Order No. S14013.A

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## Conventions Used in This Manual

The word *assert* means to drive a signal true or active. The word *deassert* means to drive a signal false or inactive. Signals that are active LOW end in a slash mark (/).



# Contents

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<b>Chapter 1</b>	<b>Introduction</b>	
1.1	General Description	1-1
1.2	Features	1-3
1.3	Application Examples	1-4
	1.3.1 Scalable Device Connectivity	1-4
	1.3.2 SCSI Bus Electrical Isolation	1-6

---

<b>Chapter 2</b>	<b>Functional Description</b>	
2.1	Interface Signal Descriptions	2-1
	2.1.1 SCSI A-Side and B-Side Single-Ended Control Blocks	2-2
	2.1.2 Re-timing Logic	2-3
	2.1.3 Precision Delay Control	2-3
	2.1.4 State Machine Control	2-4
	2.1.5 Differential Control	2-4
2.2	SCSI Signal Descriptions	2-4
	2.2.1 Data and Parity	2-5
	2.2.2 Busy (BSY) Control	2-6
	2.2.3 Reset (RST) Control	2-7
	2.2.4 Request (REQ)/Acknowledge (ACK) Control	2-7
	2.2.5 Control/Data (C/D), Input/Output (I/O), Message (MSG) and Attention (ATN) Controls	2-8
	2.2.6 Differential Direction Controls	2-8
	2.2.7 Differential Mode (DIFF_MODE/)	2-9
	2.2.8 Differential Sense (DIFF_SENSE)	2-9
	2.2.9 Control Signals	2-10

---

**Chapter 3****Specifications**

3.1	Signal Descriptions	3-1
3.1.1	LSI53C120 Pin Diagram	3-1
3.1.2	LSI53C120 Signal Grouping	3-3
3.1.3	SCSI A Interface Pins	3-4
3.1.4	SCSI B Single-ended Interface Pins	3-5
3.1.5	SCSI B Differential Interface Pins	3-6
3.1.6	Control Interface Pins	3-7
3.2	Electrical Characteristics	3-8
3.2.1	DC Characteristics	3-8
3.2.2	TolerANT Technology Electrical Characteristics	3-12
3.2.3	AC Characteristics	3-15
3.3	LSI53C120 Mechanical Drawing	3-17

---

**Appendix A****Differential Wiring Diagram**

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**Appendix B****Glossary**

---

**Index**

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**Customer Feedback**



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## Figures

1.1	LSI53C120 SCSI Bus Device	1-2
1.2	SCSI Extender Application (SE to SE Mode of Operation)	1-5
1.3	SCSI Extender or Converter Application (SE to HVD Mode of Operation)	1-5
1.4	SCSI Bus Electrical Isolation	1-6
2.1	LSI53C120 Block Diagram	2-2
2.2	LSI53C120 Signal Grouping	2-5
3.1	LSI53C120 Pin Diagram	3-2
3.2	LSI53C120 Functional Signal Grouping	3-3
3.3	Rise and Fall Time Test Conditions	3-13
3.4	SCSI Input Filtering	3-13
3.5	Hysteresis of SCSI Receiver	3-14
3.6	Input Current as a Function of Input Voltage	3-14
3.7	Output Current as a Function of Output Voltage	3-15
3.8	Clock Timing	3-16
3.9	Input/Output Timing	3-17
3.10	LSI53C120 Mechanical Drawing	3-18
A.1	LSI53C120 Differential Wiring Diagram	A-2



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## Tables

1.1	Modes of Operation	1-1
2.1	Direction Control Signals (B_SDIR(15-0), P0, P1), B_BSYDIR, B_SELDIR, B_CD_DIR, B_IO_DIR, B_MSGDIR, B_REQDIR, B_ACKDIR, B_ATNDIR and B_RSTDIR) Polarities	2-9
2.2	DIFF_MODE/ Control Signal Polarity	2-9
2.3	DIFF_SENSE Control Signal Polarity	2-10
2.4	RESET/ Control Signal Polarity	2-10
2.5	WS_ENABLE/ Signal Polarity	2-11
2.6	XFER_ACTIVE Signal Polarity	2-11
3.1	SCSI A Signal Description	3-4
3.2	SCSI B Signal Description	3-5
3.3	SCSI B Differential Signal Description	3-6
3.4	Chip Control Signal Description	3-7
3.5	SCSI Control Signal Description	3-7
3.6	Power and Ground Signal Description	3-7
3.7	No Connect Pins	3-8
3.8	Absolute Maximum Stress Ratings	3-8
3.9	Operating Conditions	3-9
3.10	SCSI Signals – A_SD(15-0)/, A_SDP(1-0)/, A_SREQ/, A_SACK/, B_SD(15-0)/, B_SDP(1-0)/, B_SREQ/, B_SACK/	3-9
3.11	SCSI Signals – A_SMSG, A_SI_O/, A_SC_D/, A_SATN/, A_SBSY/, A_SSEL/, A_SRST/, B_SMSG, B_SI_O/, B_SC_D/, B_SATN/, B_SBSY/, B_SSEL/, B_SRST/	3-10
3.12	Input Signals – CLOCK, DIFF_SENSE, DIFF_MODE/*, WS_ENABLE/*	3-10
3.13	Capacitance	3-10
3.14	Differential Signals - B_SDIR(15-0), B_SDIRP0, B_SDIRP1, B_CD_DIR, B_IO_DIR, B_MSGDIR, B_REQDIR, B_B_ACKDIR, B_BSYDIR, B_SELDIR, B_RSTDIR	3-11
3.15	Control Signals - RESET/	3-11
3.16	Control Signals - XFER_ACTIVE	3-11
3.17	TolerANT Technology Electrical Characteristics	3-12
3.18	Clock Timing	3-15
3.19	Input Timing	3-16
3.20	Output Timing	3-16



# Chapter 1

## Introduction

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This chapter describes the LSI53C120 Ultra SCSI Bus Expander and its applications. It includes these topics:

- [Section 1.1, “General Description,” page 1-1](#)
  - [Section 1.2, “Features,” page 1-3](#)
  - [Section 1.3, “Application Examples,” page 1-4](#)
- 

### 1.1 General Description

The LSI53C120 Ultra SCSI Bus Expander is a single chip solution allowing the extension of device connectivity and/or cable length limits of the SCSI bus. The LSI53C120 operates as a Ultra SCSI bus expander when multiple single-ended to single-ended cables are connected together while being electrically isolated from each other. The LSI53C120 also operates as a SCSI bus converter when single-ended to differential cables are connected together while being electrically isolated from each other.

The LSI53C120 operates in two modes: single-ended to single-ended (Extender Mode) or single-ended to High Voltage Differential (HVD) (Converter Mode). For applications requiring SE to Low Voltage Differential (LVD), use the LSI53C141 SCSI Bus Expander. [Table 1.1](#) shows all modes of operation.

**Table 1.1 Modes of Operation**

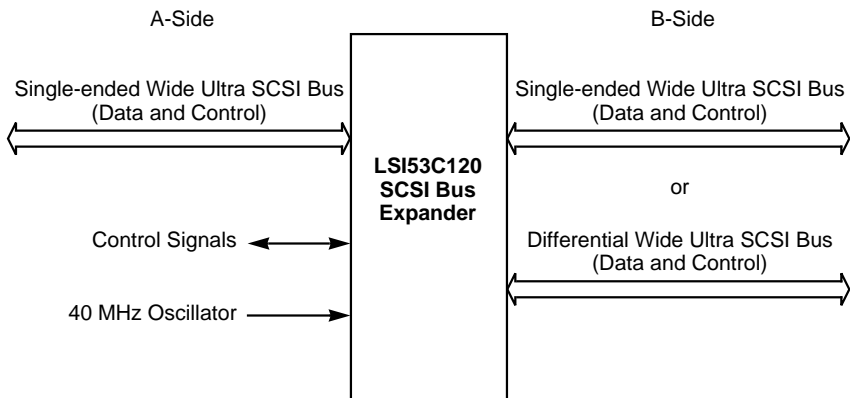
Product	Extender	Converter
LSI53C120	SE to SE	SE to HVD
LSI5353C141	SE to SE	SE to LVD

In both SCSI Bus Extender and Converter modes, cable segments are electrically isolated from each other. This feature maintains the signal integrity of each cable segment. For bus isolation applications, the LSI53C120 is ideally suited for the LSI53C875 Ultra SCSI controller.

The LSI53C120 provides additional control capability through the pin level electrical isolation mode. This feature permits logical disconnection of both the A-side bus and the B-side bus without disrupting SCSI transfers currently in progress. For example, devices on the logically disconnected B-side can be swapped out while the A-side bus remains active.

The LSI53C120 is based upon bus expander technology resulting in some signal filtering and re-timing to maintain signal skew budgets. In addition, the LSI53C120 has no programmable registers, therefore, it does not require any software.

**Figure 1.1 LSI53C120 SCSI Bus Device**



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## 1.2 Features

The LSI53C120 Ultra SCSI Bus Expander supports these features:

- Accepts any asynchronous or synchronous data transfer rates up to the 40 MB/s rate of Wide Ultra SCSI
- Allows targets and initiators to connect either to the SCSI A-side or SCSI B-side of the LSI53C120
- Does not consume a SCSI ID
- Can cascade up to three LSI53C120s in series
- Requires 40 MHz input clock
- Supports two modes of operation
  - Single-ended to Single-ended Mode
  - Single-ended to High Voltage Differential Mode (with external transceivers)
- Connects two wide and/or narrow SCSI buses
  - Extends Ultra SCSI cable lengths in certain applications
  - Extends total number of connected Ultra SCSI devices supported
- Supports TolerANT<sup>®</sup> active negation technology
- Includes complete support for SCSI-1, SCSI-2, and SCSI-3
- Does not require software
- Allows pin level SCSI bus disable mode
- Comes packaged in a 128-pin PQFP
- Includes TolerANT Technology

The LSI53C120 SCSI Bus Expander works with the extensive LSI Logic LSI53C7xx and LSI53C8xx family of SCSI products. It also works with other industry SCSI controllers, disk drives, and SCSI peripherals. Advantages of the LSI53C120 are that it does not require any software or consume a SCSI ID. This allows for easy integration and maximum bus utilization. Adding the LSI53C120 to a SCSI bus environment creates a low risk solution for applications requiring scalable device connectivity and SCSI bus electrical isolation.

[Figure 1.1](#) on [page 1-2](#) illustrates the connectivity of the LSI53C120 Ultra SCSI Bus Expander device. A SCSI Single-ended (SE) bus connects directly to the SCSI A-side. The interface signals are SCSI bus compatible driver and receiver signals with no internal termination. The SCSI B-side has the SE capable driver and receiver and also provides the individual driver controls for external High Voltage Differential (HVD) transceivers.

The LSI53C120 provides additional control capability through the pin level SCSI bus disable mode. This feature allows logical disconnection of both the A-side bus and B-side bus without disrupting transfers currently in progress. For example, this feature allows electrical disconnection of devices on the B-side to be swapped out while the A-side bus remains active.

The TolerANT technology feature prevent glitches on the SCSI bus at power-up or power-down, so other devices on the bus are also protected from data corruption. For more detailed information about this technology, refer to [Section 2.1.1.1, “TolerANT Drivers and Receivers,” page 2-3.](#)

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## 1.3 Application Examples

The following examples are typical applications for the LSI53C120 Ultra SCSI Bus Expander. Many other configurations are possible and are only limited by the imagination of the system architect.

### 1.3.1 Scalable Device Connectivity

[Figure 1.2](#) illustrates how to use the LSI53C120 to increase the number of devices to 15 on a 3 meter Ultra SCSI bus cable.



**Figure 1.2 SCSI Extender Application (SE to SE Mode of Operation)**

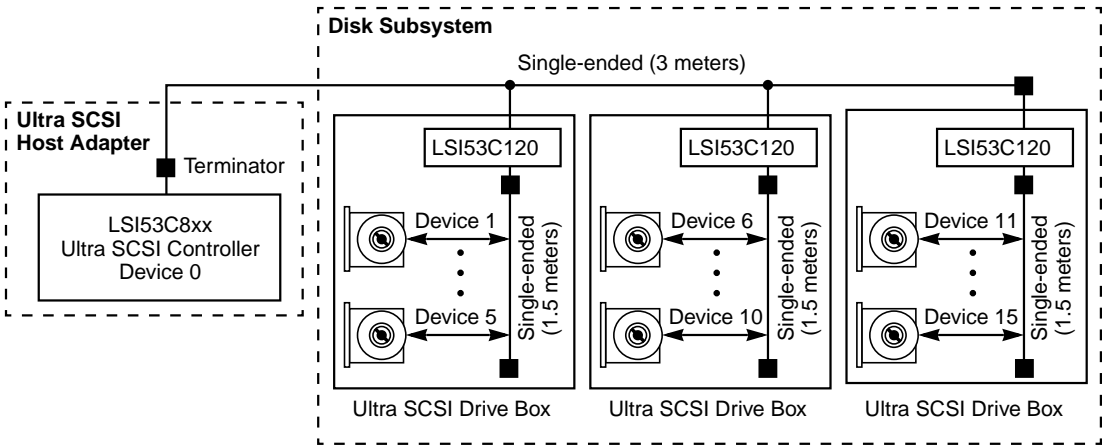
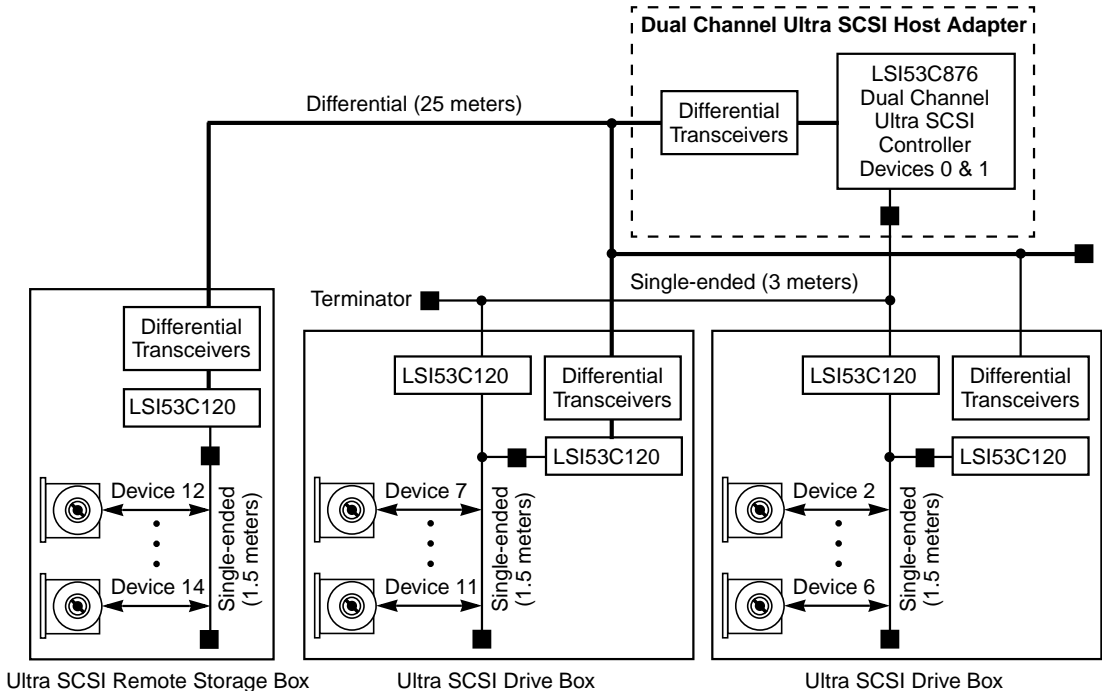


Figure 1.3 illustrates both SE to SE, and SE to HVD modes of the LSI53C120 to create a redundant remote storage configuration.

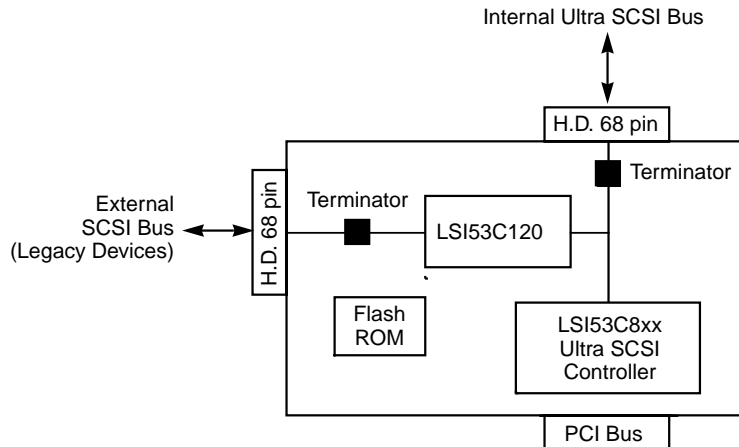
**Figure 1.3 SCSI Extender or Converter Application (SE to HVD Mode of Operation)**



## 1.3.2 SCSI Bus Electrical Isolation

Figure 1.4 illustrates how to use the LSI53C120 to electrically isolate an external SCSI bus from an internal SCSI bus. This configuration ensures externally attached peripherals will not affect the operation of internal peripherals.

**Figure 1.4 SCSI Bus Electrical Isolation**



# Chapter 2

## Functional Description

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This chapter describes all signals, their groupings and functions, and includes these topics:

[Section 2.1, "Interface Signal Descriptions," page 2-1](#)

[Section 2.2, "SCSI Signal Descriptions," page 2-4](#)

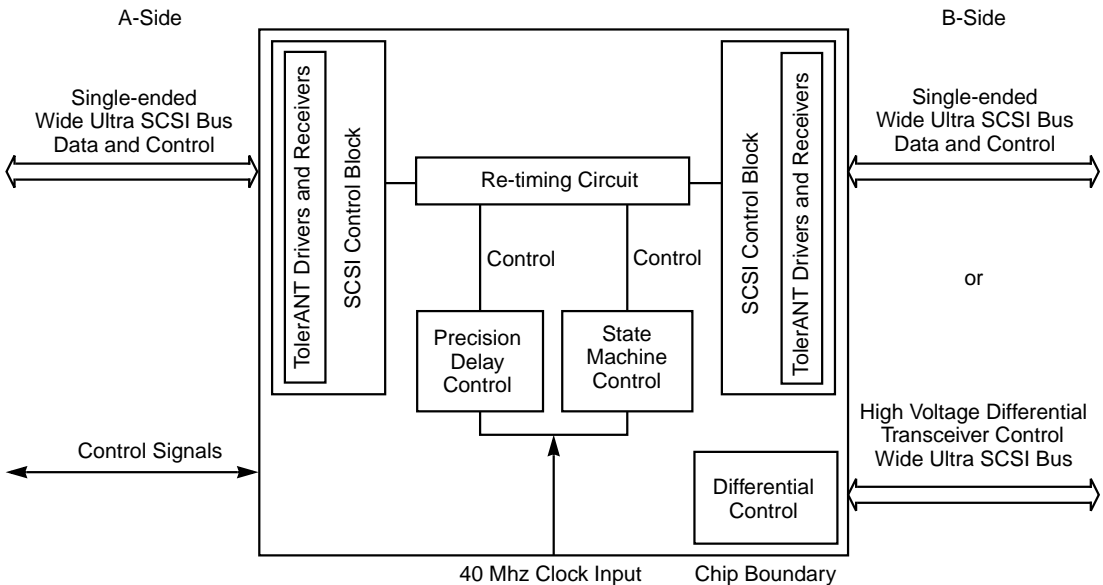
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### 2.1 Interface Signal Descriptions

The LSI53C120 has no programmable registers; therefore, no software requirements. SCSI control signals control all LSI53C120 functions. [Figure 2.1](#) on [page 2-2](#) is a diagram of the LSI53C120 device divided into the following blocks:

- SCSI A-Side and B-Side Single-Ended Control Blocks that contain TolerANT<sup>®</sup> Drivers and Receivers
- Re-timing Circuit
- Precision Delay Control
- State Machine Control
- Differential Control

**Figure 2.1 LSI53C120 Block Diagram**



In its simplest form, the LSI53C120 passes data and parity from a source bus to a load bus. The side asserting, deasserting or releasing the SCSI signals is the source side. The model of the LSI53C120 represents pieces of wire that allow corresponding SCSI signals to flow from one side to the other side. The LSI53C120 monitors arbitration and selection by devices on the bus so it can enable the proper drivers to pass the signals along. In addition, the LSI53C120 does some signal re-timing to maintain the signal skew budget from source bus to load bus.

### 2.1.1 SCSI A-Side and B-Side Single-Ended Control Blocks

In the Single-ended (SE) to Single-ended mode, the SCSI A-side pins are connected internally to the corresponding SCSI B-side pins, forming bi-directional connections to the SCSI bus.

The SCSI A-side and B-side SE control blocks connect to both targets and initiators and accept any asynchronous or synchronous data transfer rates up to the 40 Mbytes/s rate of Wide Ultra SCSI. TolerANT technology is part of the SCSI A-side and B-side SE control blocks.

### **2.1.1.1 TolerANT Drivers and Receivers**

The LSI53C120 features TolerANT technology, which includes active negation on the SCSI drivers and input signal filtering on the SCSI receivers. Active negation causes the SCSI Request, Acknowledge, Data, and Parity signals to be actively driven HIGH rather than passively pulled up by terminators.

TolerANT receiver technology improves data integrity in unreliable cabling environments, where other devices would be subject to data corruption. TolerANT receivers filter the SCSI bus signals to eliminate unwanted transitions, without the long signal delay associated with RC-type input filters. This improved driver and receiver technology helps eliminate double clocking of data, the single biggest reliability issue with SCSI operations.

The benefits of TolerANT include increased immunity to noise on the deasserting signal edge, better performance due to balanced duty cycles, and improved SCSI transfer rates. In addition, TolerANT SCSI devices prevent glitches on the SCSI bus at power-up or power-down, so other devices on the bus are also protected from data corruption.

### **2.1.2 Re-timing Logic**

The SCSI signals, as they propagate from one side of the LSI53C120 to the other side, are processed by logic that re-times the bus signals as needed to guarantee or improve required SCSI timings. The state machine controls govern the re-timing logic to keep track of SCSI phases, the location of initiator and target devices, and various timing functions. In addition, the re-timing logic contains numerous precision delay elements that are periodically calibrated by the Precision Delay Control block in order to guarantee specified timings such as output pulse widths, setup and hold times, and other elements.

### **2.1.3 Precision Delay Control**

The Precision Delay Control block provides calibration information to the precision delay elements in the Re-timing Logic block. This calibration information provides precise timings as signals propagate through the device. As the LSI53C120 voltage and temperature vary over time, the Precision Delay Control block periodically updates the delay settings in

the Re-timing Logic to maintain constant and precise control over bus timings.

#### **2.1.4 State Machine Control**

The State Machine Control tracks the SCSI bus phase protocol and other internal operating conditions. This block provides signals to the Re-timing Logic that identifies how to properly handle SCSI bus signal re-timing based on SCSI protocol.

#### **2.1.5 Differential Control**

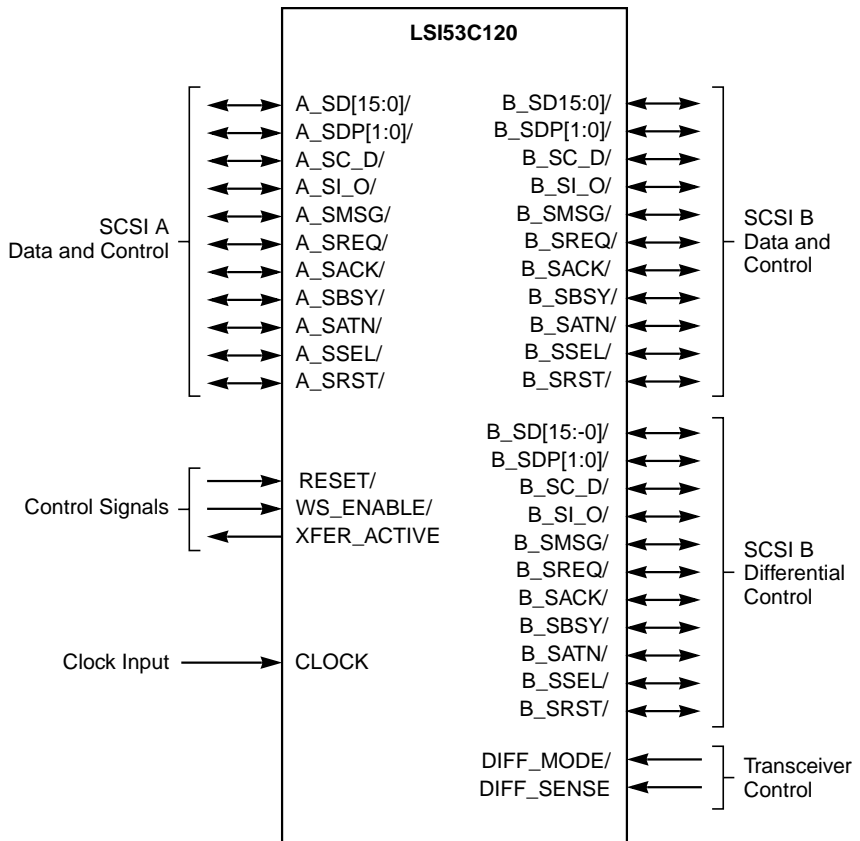
In the SCSI converter (SE to High Voltage Differential (HVD)) mode, the SCSI A-side pins are connected internally to the corresponding SCSI B-side differential pins, forming bidirectional connections to the SCSI bus.

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## **2.2 SCSI Signal Descriptions**

[Figure 2.2](#) illustrates the signal groupings of the LSI53C120. A description of the signal groups follows. For a description of a specific signal, refer to [Section 3.1, “Signal Descriptions,” page 3-1](#). See [Section 3.2, “Electrical Characteristics,” page 3-8](#) about signal electrical characteristics.

**Figure 2.2 LSI53C120 Signal Grouping**



## 2.2.1 Data and Parity

The signals named A\_SD[15:0]/ and A\_SDP[1:0]/ are the data and parity signals from the A-side and B\_SD[15:0]/ and B\_SDP[1:0]/ are the data and parity signals from the B-side of the LSI53C120. The LSI53C120 sends and receives these signals by using SCSI compatible driver and receiver logic designed into the LSI53C120 interfaces. This logic provides the necessary drive, sense thresholds, and input hysteresis to function correctly in a SCSI bus environment.

The LSI53C120 receives data and parity signals and passes them from the source bus to the load bus and provides any necessary edge shifting to guarantee the skew budget for the load bus. Either side of the

LSI53C120 can be the source bus or the load bus. The side asserting, deasserting, or releasing the SCSI signals is the source side. The following steps are a part of the LSI53C120 data path.

1. The receiver logic accepts the asserted data as soon as it is received. Once the clock signal (REQ/ACK) has been received, then the receiver latch gates the data.
2. The path is tested to ensure the signal if being driven by the LSI53C120 is not misinterpreted as an incoming signal.
3. The data is leading edge filtered. The assertion edge is held for a specified time to prevent any signal bounce. The input signal controls the duration.
4. A latch samples the signal. This provides a stable data window for the load bus.
5. The final stage develops pull-up and pull-down controls for the SCSI I/O logic, including 3-state controls for the pull-up.
6. A parallel function ensures that bus (transmission line) recovery is ensured for a specified time after the last signal deassertion on each signal line.

## 2.2.2 Busy (BSY) Control

The LSI53C120 propagates the A\_SBSY/ and B\_SBSY/ signals from the source bus to the load bus. The following steps describe this process.

1. The bus is tested to ensure the signal if being driven by the LSI53C120 is not misinterpreted as an incoming signal.
2. The data is leading edge filtered. The assertion edge is held for a specified time to prevent any signal bounce. The input signal controls the duration.
3. The signal path switches the long and short filters used in the circuit depending upon the current state of the LSI53C120. The current state of the LSI53C120 State Machine that tracks SCSI phases selects the mode. The short filter mode passes data through, while the long filter mode indicates the bus free state. When the Busy (SBSY) and Select (SSEL) sources switch from side to side, the long filter mode is used. This output is then fed to the output driver, which is a pull-down open collector only.



4. A parallel function ensures that bus (transmission line) recovery is ensured for a specified time after the last signal deassertion on each signal line.

### 2.2.3 Reset (RST) Control

The LSI53C120 passes A\_SRST/ and B\_SRST/ reset signals from the source to the load bus. The following steps describe this process.

1. The LSI53C120 blocks another RST input signal if one is already being driven from the source to the load bus.
2. The next stage is a leading edge filter. This ensures that the output does not switch for a specified time after the leading edge. The duration of the input signal then determines the duration of the output.
3. A parallel function ensures that bus (transmission line) recovery is ensured for a specified time after the last signal deassertion on each signal line.

### 2.2.4 Request (REQ)/Acknowledge (ACK) Control

A\_SACK/, B\_SACK/, A\_SREQ/ and B\_SREQ/ are clock and control signals. Their signal paths contain controls to guarantee minimum pulse width, filter edges, and does some re-timing when used as data transfer clocks. Each signal, REQ and ACK, has paths from A to B and B to A. The received signal goes through the following processing steps before being sent to the opposite bus.

1. The asserted input signal is sensed and forwarded to the next stage if the direction control permits it. The direction controls are developed from state machines that are driven by the sequence of bus control signals.
2. The signal must then pass the test of *not* being generated by the LSI53C120.
3. The next stage is a leading edge filter. This ensures that the output does not switch during the specified hold time after the leading edge. The duration of the input signal determines the duration of the output after the hold time. The circuit guarantees a minimum pulse.
4. The next stage passes the signal if it is not a data clock. If REQ or ACK is a data clock, it delays the leading edge to improve data

output setup times. The duration is again controlled by the input signal.

5. This stage is a trailing edge signal filter. When the signal deasserts, the filter does not permit any signal bounce. The output signal deasserts at the first deasserted edge of the input signal.
6. The final stage develops pull-up and pull-down signals with drive and 3-state control.
7. A parallel function ensures that bus (transmission line) recovery is ensured for a specified time after the last signal deassertion on each signal line.

## **2.2.5 Control/Data (C/D), Input/Output (I/O), Message (MSG) and Attention (ATN) Controls**

A\_SCD/, A\_SIO/, A\_SMSG/, A\_SATN/, B\_SCD/, B\_SIO/, B\_SMSG/ and B\_SATN/ are control signals. The following steps describe the process regarding these control signals:

1. The LSI53C120 blocks another input signal if one is already being driven from the source to the load bus.
2. The next stage is a leading edge filter. This ensures that the output does not switch for a specified time after the leading edge. The duration of the input signal then determines the duration of the output.
3. The final stage develops pull-up and pull-down controls for the SCSI I/O logic, including 3-state controls for the pull-up.
4. A parallel function ensures that bus (transmission line) recovery is ensured for a specified time after the last signal deassertion on each signal line.

## **2.2.6 Differential Direction Controls**

B\_SDIR(15-0, P0, P1), B\_BSYDIR, B\_SELDIR, B\_CD\_DIR, B\_IO\_DIR, B\_MSGDIR, B\_REQDIR, B\_ACKDIR, B\_ATNDIR and B\_RSTDIR are all differential direction control signals on the B-side of the LSI53C120. When the B-side is used in SE mode, these signals are not used and should be left unconnected. When the B-side is used in HVD mode, these signals control the direction of each external differential transceiver on the B-side interface.

Every B-side signal requires a driver enable control to allow for all the possible signal conditions including SCAM support. The data bits require individual controls for the selection phase of SCSI bus protocol. [Table 2.1](#) shows the Direction Control Signals to illustrate their possible signal levels, states and subsequent effects.

**Table 2.1 Direction Control Signals (B\_SDIR(15-0, P0, P1), B\_BSYDIR, B\_SELDIR, B\_CD\_DIR, B\_IO\_DIR, B\_MSGDIR, B\_REQDIR, B\_ACKDIR, B\_ATNDIR and B\_RSTDIR) Polarities**

Signal Level	State	Effect
HIGH = 1	Asserted	Drive LSI53C120 signals onto Bus B
LOW = 0	Deasserted	Input Bus B signals to LSI53C120

## 2.2.7 Differential Mode (DIFF\_MODE/)

This input informs the LSI53C120 that external differential transceivers are used in this particular application. In addition, this input causes internal logic to adjust for external differential control. [Table 2.2](#) shows the DIFF\_MODE/ control signal polarity to illustrate its possible signal levels, states and subsequent effects.

**Table 2.2 DIFF\_MODE/ Control Signal Polarity**

Signal Level	State	Effect
LOW = 0	Asserted	Differential Signals and Controls are enabled from the LSI53C120
HIGH = 1	Deasserted	LSI53C120 Bus B drivers function in single-ended mode

## 2.2.8 Differential Sense (DIFF\_SENSE)

This input signal determines if a single-ended device is placed on the differential bus. If a single-ended source is detected, the differential B-side is disabled and no differential B-side signals are driven. This mechanism prevents potential damage to the HVD transceivers.

Table 2.3 shows the DIFF\_SENSE control signal polarity to illustrate its possible signal levels, states and subsequent effects.

**Table 2.3 DIFF\_SENSE Control Signal Polarity**

Signal Level	State	Effect
HIGH = 1	Asserted	The B-side drivers and receivers are enabled.
LOW = 0	Deasserted	B-side drivers and receivers are disabled.

## 2.2.9 Control Signals

This section provides information about the RESET/, WS\_ENABLE/, and XFER\_ACTIVE pins. It also describes the function of the CLOCK input.

### 2.2.9.1 Chip Reset (RESET/)

This general purpose chip reset forces all the internal elements of the LSI53C120 into a known state. It brings the State Machine to an idle state and forces all controls to a passive state. The minimum RESET/ input asserted pulse width is 100 ns.

The LSI53C120 also contains an internal Power On Reset (POR) function that is ORed with the chip reset pin. This eliminates the need for an external chip reset if the power supply meets ramp up specifications.

**Table 2.4 RESET/ Control Signal Polarity**

Signal Level	State	Effect
LOW = 0	Asserted	Reset is forced to all internal LSI53C120 elements.
HIGH = 1	Deasserted	LSI53C120 is not in a forced reset state.

### 2.2.9.2 Warm Swap Enable (WS\_ENABLE/)

This input provides additional control capability for the LSI53C120. It allows both the SCSI A-side bus and the SCSI B-side bus to be logically disconnected. When the WS\_ENABLE/ pin is asserted, after detection of the next Bus Free state, the SCSI signals are 3-stated. This occurs so

that the LSI53C120 no longer passes through signals until the WS\_ENABLE/ pin is deasserted HIGH and both SCSI buses enter the Bus Free state. As an indication that the chip is idle, or ready to be warm swapped, the XFER\_ACTIVE signal deasserts LOW. An LED or some other indicator could be connected to the XFER\_ACTIVE signal. LSI Logic recommends using the Warm Swap Enable feature to isolate buses for specific situations.

**Table 2.5 WS\_ENABLE/ Signal Polarity**

Signal Level	State	Effect
LOW = 0	Asserted	The LSI53C120 is requested to go off-line after detection of a SCSI Bus Free state
HIGH = 1	Deasserted	The LSI53C120 is enabled to run normally.

### 2.2.9.3 Transfer Active (XFER\_ACTIVE)

This output is an indication that the chip has finished its internal testing, the SCSI bus has entered a Bus Free state, and SCSI traffic can no pass from one bus to the other. The signal is asserted HIGH when the chip is active.

**Table 2.6 XFER\_ACTIVE Signal Polarity**

Signal Level	State	Effect
HIGH = 1	Asserted	Indicates normal operation, and transfers through the LSI53C120 are enabled
LOW = 0	Deasserted	The LSI53C120 has detected a Bus Free state due to WS_ENABLE/ being LOW, thus disabling transfers through the device.

### 2.2.9.4 Clock (CLOCK)

This is the 40 MHz oscillator input to the LSI53C120. This is the clock source for protocol control state machines and timing generation logic. This clock is not used in any bus signal transfer paths.



# Chapter 3

## Specifications

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This chapter provides technical specifications regarding the LSI53C120 Ultra SCSI Bus Expander and includes these topics:

- [Section 3.1, “Signal Descriptions,” page 3-1](#)
  - [Section 3.2, “Electrical Characteristics,” page 3-8](#)
  - [Section 3.3, “LSI53C120 Mechanical Drawing,” page 3-17](#)
- 

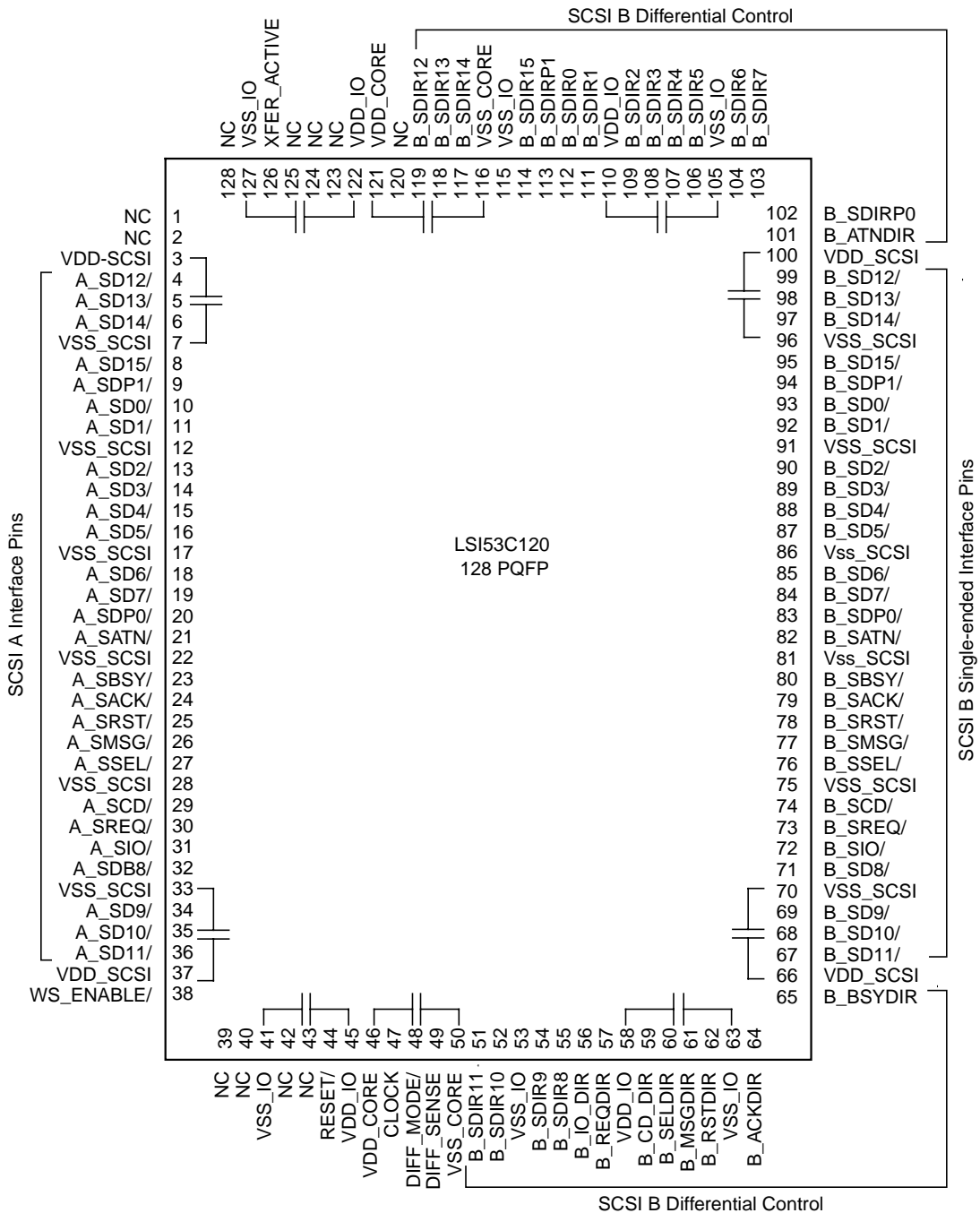
### 3.1 Signal Descriptions

The LSI53C120 is packaged in a 128-pin Plastic Quad Flat Pack (PQFP). Detailed descriptions follow, grouped by function. The decoupling capacitor arrangement shown below is recommended to maximize the benefits of the internal split ground system. Capacitor values should be between 0.01  $\mu$ F and 0.1  $\mu$ F.

#### 3.1.1 LSI53C120 Pin Diagram

[Figure 3.1](#) on [page 3-2](#) shows the LSI53C120 128-pin Plastic Quad Flat Pack (PQFP) pin diagram.

**Figure 3.1 LSI53C120 Pin Diagram**

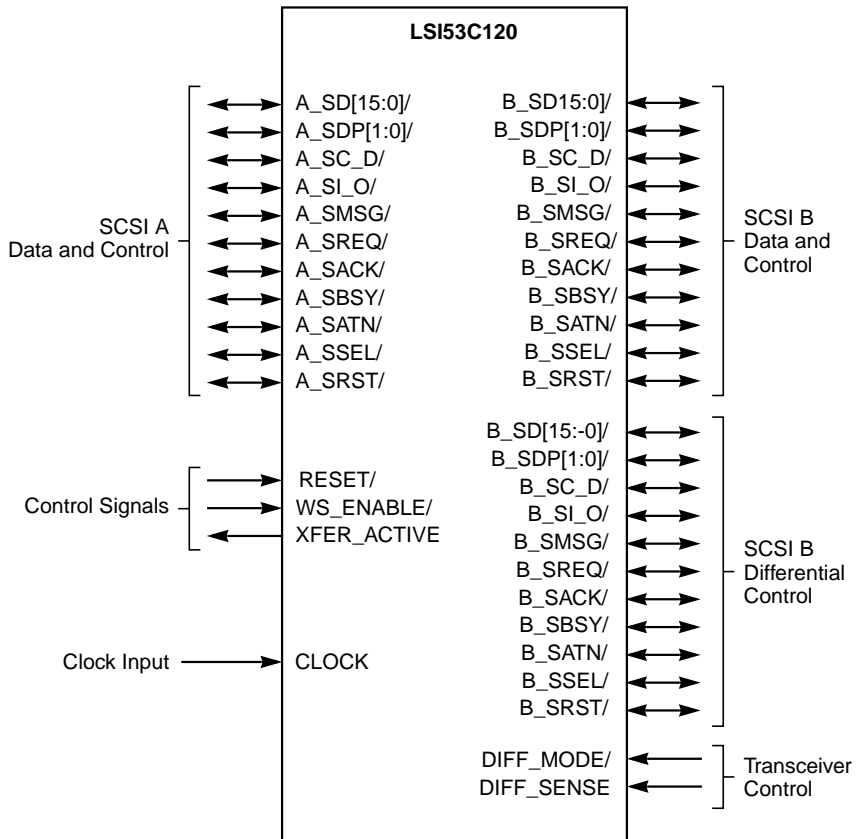




### 3.1.2 LSI53C120 Signal Grouping

Figure 3.2 shows the decoupling capacitor arrangement.

**Figure 3.2 LSI53C120 Functional Signal Grouping**



### 3.1.3 SCSI A Interface Pins

Table 3.1 lists the SCSI A side interface pins associated with the 128-pin Plastic Quad Flat Pack (PQFP).

**Table 3.1 SCSI A Signal Description**

SCSI A	Pin	Type	Strength	Description
A_SD[15:0]	8, 6, 5, 4, 36, 35, 34, 32, 19, 18, 16, 15, 14, 13, 11, 10	I/O	48 mA	Data (16-bit SCSI bus)
A_SDP/(1-0)	9, 20	I/O	48 mA	Data parity bits
A_SCD/	29	I/O	48 mA	Phase line, command/data
A_SIO/	31	I/O	48 mA	Phase line, input/output
A_SMSG/	26	I/O	48 mA	Phase line, message
A_SREQ/	30	I/O	48 mA	Data handshake signal from target device
A_SACK/	24	I/O	48 mA	Data handshake signal from initiator device
A_SBSY/	23	I/O	48 mA	Bus arbitration signal, busy
A_SATN/	21	I/O	48 mA	Attention, the initiator is requesting a message out phase
A_SSEL/	27	I/O	48 mA	Bus arbitration signal, select device
A_SRST/	25	I/O	48 mA	Bus Reset

### 3.1.4 SCSI B Single-ended Interface Pins

Table 3.2 lists the SCSI B side single-ended interface pins associated with the 128 pin Plastic Quad Flat Pack (PQFP).

**Table 3.2 SCSI B Signal Description**

SCSI B	Pin	Type	Strength	Description
B_SD/(15-0)	95, 97, 98, 99, 67, 68, 69, 71, 84, 85, 87, 88, 89, 90, 92, 93	I/O	48 mA	Data (16-bit SCSI bus)
B_SDP/(1-0)	94, 83	I/O	48 mA	Data parity bits
B_SCD/	74	I/O	48 mA	Phase line, command/data
B_SIO/	72	I/O	48 mA	Phase line, input/output
B_SMSG/	77	I/O	48 mA	Phase line, message
B_SREQ/	73	I/O	48 mA	Data handshake signal from target device
B_SACK/	79	I/O	48 mA	Data handshake signal from initiator device
B_SBSY/	80	I/O	48 mA	Bus arbitration signal, busy
B_SATN/	82	I/O	48 mA	Attention, the initiator is requesting a message out phase
B_SSEL/	76	I/O	48 mA	Bus arbitration signal, select device
B_SRST/	78	I/O	48 mA	Bus Reset

### 3.1.5 SCSI B Differential Interface Pins

Table 3.3 lists the High Voltage Differential (HVD) interface pins associated with the 128-pin Plastic Quad Flat Pack (PQFP).

**Table 3.3 SCSI B Differential Signal Description**

SCSI B Differential	Pin	Type	Strength	Description
B_SDIR(15-0)	114, 117, 118, 119, 51, 52, 54, 55, 103, 104, 106, 107, 108, 109, 111, 112	O	4 mA	Driver direction control for SCSI data line
B_SDIRP(1-0)	113, 102	O	4 mA	Driver direction control for SCSI parity signals
B_CD_DIR	59	O	4 mA	Driver direction control for CD/
B_IO_DIR	56	O	4 mA	Driver direction control for IO/
B_MSGDIR	61	O	4 mA	Driver direction control for MSG/
B_REQDIR	57	O	4 mA	Driver direction control for REQ/
B_ACKDIR	64	O	4 mA	Driver direction control for ACK/
B_BSYDIR	65	O	4 mA	Driver direction control for BSY/
B_ATNDIR	101	O	4 mA	Driver direction control for ATN/
B_SELDIR	60	O	4 mA	Driver direction control for SEL/
B_RSTDIR	62	O	4 mA	Driver direction control for RST/

### 3.1.6 Control Interface Pins

Tables 3.4 through 3.7 list the various control interface pins.

**Table 3.4 Chip Control Signal Description**

Control	Pin	Type	Strength	Description
RESET/	44	I		Master reset, active low.
WS_ENABLE/	38	I		Enable/disable SCSI transfers through the LSI53C120.
XFER_ACTIVE	126	O	16 mA	Transfers through the LSI53C120 are enabled/disabled.

**Table 3.5 SCSI Control Signal Description**

SCSI Control	Pin	Type	Description
CLOCK	47	I	40 MHz input clock
DIFF_MODE/	48	I	SCSI B-side bus mode control
DIFF_SENSE	49	I	The DIFF_SENSE pin detects the presence of a single-ended device on a differential system. This pin should be tied low during single-ended operation and pulled high during differential operation.

**Table 3.6 Power and Ground Signal Description**

Power and Ground	Pin	Type	Description
VDD-SCSI	3, 37, 66, 100	I/O	Power supplies to the SCSI bus I/O pins
VSS-SCSI	7, 12, 17, 22, 28, 33, 70, 75, 81, 86, 91, 96	I/O	Power supplies to the SCSI bus I/O pins
VSS_IO	41, 53, 63, 105, 115, 127	I/O	Power supplies to the I/O pins
VDD_IO	45, 58, 110, 122	I/O	Power supplies to the I/O pins
VDD_CORE	46, 121	CORE	Power supplies to the CORE logic
VSS_CORE	50, 116	CORE	Power supplies to the CORE logic

**Table 3.7 No Connect Pins**

No Connects	Pin	Type	Description
NC	39, 40, 42, 43, 120, 123, 124		No external connection required.
Require pullups	1, 2, 128		Requires a pullup.
Require pulldown	125		Requires a pulldown with a 1K ohm resistor.

## 3.2 Electrical Characteristics

This section provides information about the DC and AC characteristics for the LSI53C120 Ultra SCSI Bus Expander.

### 3.2.1 DC Characteristics

Table 3.8 lists the maximum stress ratings for the LSI53C120 device.

**Table 3.8 Absolute Maximum Stress<sup>1</sup> Ratings**

Symbol	Parameter	Min	Max	Unit	Test Conditions
T <sub>STG</sub>	Storage temperature	-55	150	°C	–
V <sub>DD</sub>	Supply voltage	-0.5	7.0	V	–
V <sub>IN</sub>	Input Voltage	V <sub>SS</sub> - 0.5	V <sub>DD</sub> + 0.5	V	–
I <sub>LP</sub> <sup>2</sup>	Latch-up current	± 150	–	mA	–
ESD <sup>3</sup>	Electrostatic discharge	–	2K	V	MIL-STD 883C, Method 3015.7

1. Stresses beyond those listed above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions beyond those indicated in the Operating Conditions section of the manual is not implied.
2. -2V < VPIN < 8V
3. SCSI pins only

Table 3.9 lists the operating conditions for the LSI53C120 device.

**Table 3.9 Operating Conditions<sup>1</sup>**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>DD</sub>	Supply voltage	4.75	5.25	V	–
I <sub>DD</sub>	Supply current (dynamic) Supply current (static)	–	80 1	mA mA	– –
T <sub>A</sub>	Operating free air	0	70	°C	–
θ <sub>JA</sub>	Thermal resistance (junction to ambient air)	–	41.3	°C/W	–

1. Conditions that exceed the operating limits may cause the device to function incorrectly.

Table 3.10 provides the minimum and maximum values associated with these LSI53C120 SCSI signals.

**Table 3.10 SCSI Signals – A\_SD(15-0)/, A\_SDP(1-0)/, A\_SREQ/, A\_SACK/, B\_SD(15-0)/, B\_SDP(1-0)/, B\_SREQ/, B\_SACK/**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>IH</sub>	Input high voltage	1.9	V <sub>DD</sub> + 0.5	V	–
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> - 0.5	1.0	V	–
V <sub>OH</sub> <sup>1</sup>	Output high voltage	2.4	3.5	V	2.5 mA
V <sub>OL</sub>	Output low voltage	V <sub>SS</sub>	0.4	V	48 mA
I <sub>OZ</sub>	3-state leakage	-10	10	μA	–

1. TolerANT active negation enabled

Table 3.11 provides the minimum and maximum values for these LSI53C120 SCSI signals.

**Table 3.11 SCSI Signals – A\_SMSG, A\_SI\_O/, A\_SC\_D/, A\_SATN/, A\_SBSY/, A\_SSEL/, A\_SRST/, B\_SMSG, B\_SI\_O/, B\_SC\_D/, B\_SATN/, B\_SBSY/, B\_SSEL/, B\_SRST/**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>IH</sub>	Input high voltage	1.9	V <sub>DD</sub> + 0.5	V	–
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> - 0.5	1.0	V	–
V <sub>OL</sub>	Output low voltage	V <sub>SS</sub>	0.5	V	48 mA
I <sub>OZ</sub>	3-state leakage (SRST/ only)	-10 -500	10 -50	μA	–

Table 3.12 provides the minimum and maximum values for the LSI53C120 Input signals.

**Table 3.12 Input Signals – CLOCK, DIFF\_SENSE, DIFF\_MODE/\*, WS\_ENABLE/\***

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>IH</sub>	Input high voltage	2.0	V <sub>DD</sub> + 0.5	V	–
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> - 0.5	0.8	V	–
I <sub>IN</sub>	Input leakage	-10 <sup>1</sup>	10	μA	–

1. The minimum (I<sub>IN</sub>) Input leakage for DIFF\_MODE/ and WS\_ENABLE/ is -100 μA.

Table 3.13 provides the minimum and maximum values concerning capacitance for the LSI53C120.

**Table 3.13 Capacitance**

Symbol	Parameter	Min	Max	Unit	Test Conditions
C <sub>I</sub>	Input capacitance of input pads	–	7	pF	–
C <sub>IO</sub>	Input capacitance of I/O pads	–	10	pF	–



Table 3.14 provides the minimum and maximum values for the LSI53C120 Differential signals.

**Table 3.14 Differential Signals - B\_SDIR(15-0), B\_SDIRP0, B\_SDIRP1, B\_CD\_DIR, B\_IO\_DIR, B\_MSGDIR, B\_REQDIR, B\_B\_ACKDIR, B\_BSYDIR, B\_SELDIR, B\_RSTDIR**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>OH</sub>	Output high voltage	2.4	V <sub>DD</sub>	V	-4 mA
V <sub>OL</sub>	Output low voltage	V <sub>SS</sub>	0.4	V	4 mA
I <sub>OZ</sub>	3-state leakage	-10	10	μA	–

Tables 3.15 and 3.16 provide the minimum and maximum values for the LSI53C120 Control signals.

**Table 3.15 Control Signals - RESET/**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>IH</sub>	Input high voltage	3.5	V <sub>DD</sub> + 0.5	V	–
V <sub>IL</sub>	Input low voltage	V <sub>SS</sub> - 0.5	1.5	V	–
I <sub>OZ</sub>	3-state leakage	-10	10	μA	–

**Table 3.16 Control Signals - XFER\_ACTIVE**

Symbol	Parameter	Min	Max	Unit	Test Conditions
V <sub>OH</sub>	Output high voltage	2.4	V <sub>DD</sub>	V	16 mA
V <sub>OL</sub>	Output low voltage	V <sub>SS</sub>	0.4	V	16 mA
I <sub>OZ</sub>	3-state leakage	-10	10	μA	–

### 3.2.2 TolerANT Technology Electrical Characteristics

Table 3.17 provides the minimum and maximum values for the LSI53C120 TolerANT technology electrical characteristics.

**Table 3.17 TolerANT Technology Electrical Characteristics<sup>1</sup>**

Symbol	Parameter	Min	Max	Units	Test Conditions
$V_{OH}^2$	Output high voltage	2.5	3.5	V	$I_{OH} = 2.5 \text{ mA}$
$V_{OL}$	Output low voltage	0.1	0.5	V	$I_{OL} = 48 \text{ mA}$
$V_{IH}$	Input high voltage	1.9	7.0	V	–
$V_{IL}$	Input low voltage	-0.5	1.0	V	Referenced to $V_{SS}$
$V_{IK}$	Input clamp voltage	-0.66	-0.77	V	$V_{DD} = 4.75$ ; $I_I = -20 \text{ mA}$
$V_{TH}$	Threshold, high to low	1.1	1.3	V	–
$V_{TL}$	Threshold, low to high	1.5	1.7	V	–
$V_{TH}-V_{TL}$	Hysteresis	200	400	mV	–
$I_{OH}^2$	Output high current	2.5	24	mA	$V_{OH} = 2.5 \text{ V}$
$I_{OL}$	Output low current	100	200	mA	$V_{OL} = 0.5 \text{ V}$
$I_{OSH}^2$	Short-circuit output high current	–	625	mA	Output driving low, pin shorted to $V_{DD}$ supply <sup>3</sup>
$I_{OSL}$	Short-circuit output low current	–	95	mA	Output driving high, pin shorted to $V_{SS}$ supply
$I_{LH}$	Input high leakage	–	10	$\mu\text{A}$	$-0.5 < V_{DD} < 5.25$ $V_{PIN} = 2.7 \text{ V}$
$I_{LL}$	Input low leakage	–	-10	$\mu\text{A}$	$-0.5 < V_{DD} < 5.25$ $V_{PIN} = 0.5 \text{ V}$
$R_I$	Input resistance	20	–	$\text{M}\Omega$	SCSI pins <sup>4</sup>
$C_P$	Capacitance per pin	–	10	pF	PQFP
$t_R^2$	Rise time, 10% to 90%	9.7	18.5	ns	Figure 3.4

**Table 3.17 TolerANT Technology Electrical Characteristics<sup>1</sup> (Cont.)**

Symbol	Parameter	Min	Max	Units	Test Conditions
$t_F$	Fall time, 90% to 10%	5.2	14.7	ns	Figure 3.4
$dV_H/dt$	Slew rate, low to high	0.15	0.49	V/ns	Figure 3.3
$dV_L/dt$	Slew rate, high to low	0.19	0.67	V/ns	Figure 3.3
ESD	Electrostatic discharge	2	–	KV	MIL-STD-883C; 3015-7
	Latch-up	100	–	mA	–
$t_1$	Filter delay	10	15	ns	Figure 3.4

1. These values are guaranteed by periodic characterization; they are not 100% tested on every device.
2. Active negation outputs only: Data, Parity, SREQ/, SACK/
3. Single pin only; irreversible damage may occur if sustained for one second.
4. SCSI RESET pin has 10 k $\Omega$  pull-up resistor.

Figure 3.3 shows the rise and fall time test conditions described in Table 3.17.

**Figure 3.3 Rise and Fall Time Test Conditions**

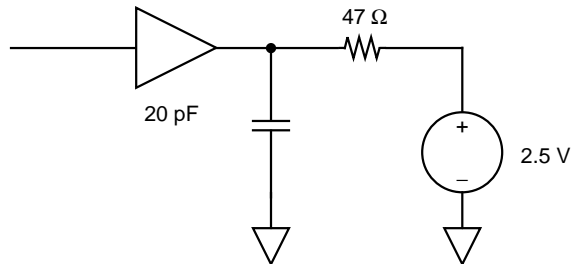
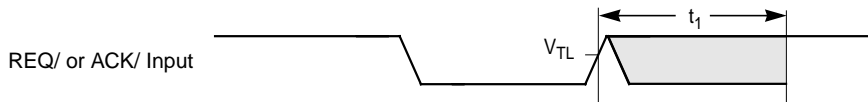


Figure 3.4 shows the SCSI input filtering described in Table 3.17.

**Figure 3.4 SCSI Input Filtering**



Note:  $t_1$  is the input filtering period.

Figure 3.5 shows the hysteresis of a SCSI receiver.

**Figure 3.5 Hysteresis of SCSI Receiver**

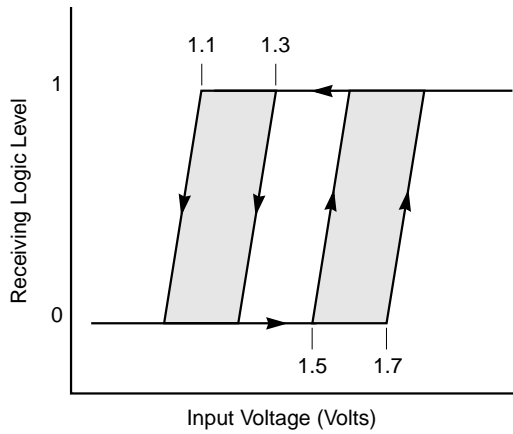


Figure 3.6 shows input current as a function of input voltage.

**Figure 3.6 Input Current as a Function of Input Voltage**

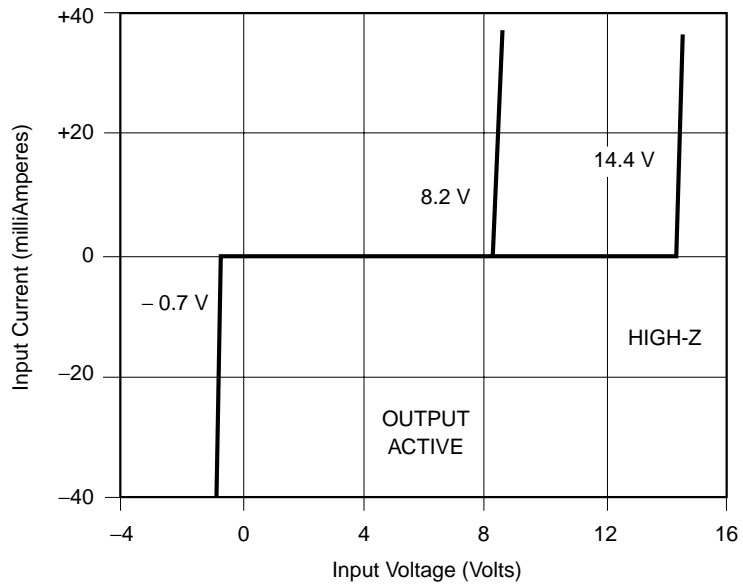
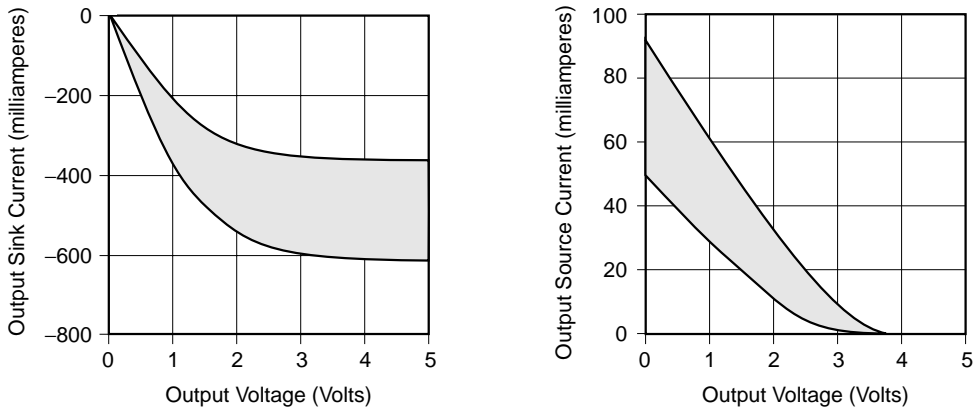


Figure 3.7 shows output current as a function of output voltage.

**Figure 3.7 Output Current as a Function of Output Voltage**



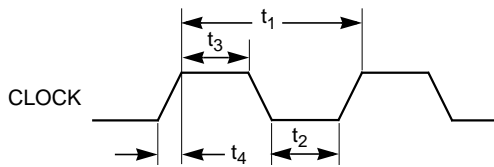
### 3.2.3 AC Characteristics

The AC characteristics described in this section apply over the entire range of operating conditions (refer to the DC Characteristics section). Chip timings (Figure 3.8 on page 3-16) are based on simulation at worst case voltage, temperature, and processing. The LSI53C120 requires a 40 MHz clock input. (See Table 3.18.)

**Table 3.18 Clock Timing**

Symbol	Parameter	Min	Max	Units
$t_1$	Clock period	24.5	25.5	ns
$t_2$	Clock low time	10	15	ns
$t_3$	Clock high time	10	15	ns
$t_4$	Clock rise time	1	—	V/ns

**Figure 3.8 Clock Timing**



### 3.2.3.1 SCSI Interface Timing

Table 3.19 shows the SCSI interface input timing, Table 3.20 shows the SCSI interface output timing, and Figure 3.9 on page 3-17 shows the input/output timing diagram.

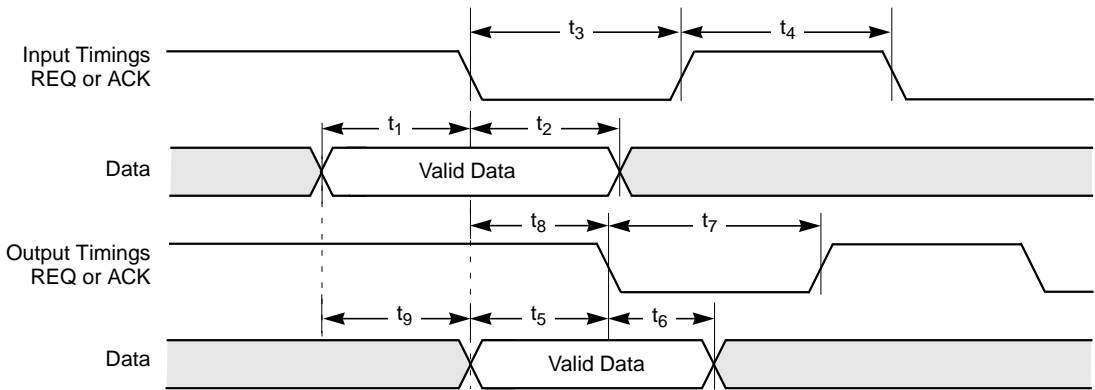
**Table 3.19 Input Timing**

Symbol	Parameter	Min	Max	Units
$t_1$	Input data setup	1	-	ns
$t_2$	Input data hold	6	-	ns
$t_3$	Input REQ/ACK assertion pulse width	11	-	ns
$t_4$	Input REQ/ACK deassertion pulse width	16	-	ns

**Table 3.20 Output Timing**

Symbol	Parameter	Min	Max	Units
$t_5$	Output data setup	min [ $t_1 + 17\text{ns}$ , $t_4+5$ ]	-	ns
$t_6$	Output data hold	max [24, ( $t_2 - 20$ ), $t_3$ ]	-	ns
$t_7$	Output REQ/ACK pulse width	max [20 ns, $t_3 - 5$ ]	max [30 ns, $t_3 + 5$ ]	ns
$t_8$	REQ/ACK transport delay	25 ns if REQ/ACK is clock for input data, 10 ns if not	50 ns if REQ/ACK is clock for input data, 30 ns if not	ns
$t_9$	Data transport delay	6	[ $t_3 + 35$ ]	ns

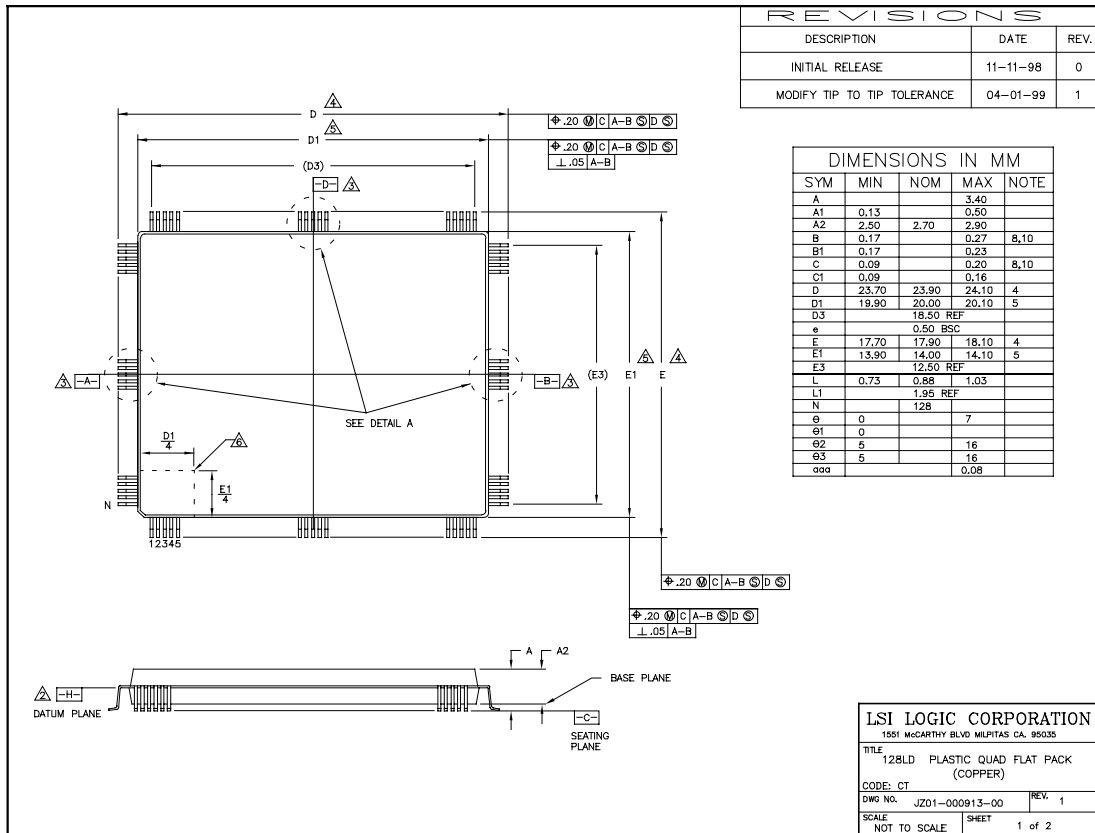
**Figure 3.9 Input/Output Timing**



### 3.3 LSI53C120 Mechanical Drawing

The LSI53C120 comes in a 128-pin metric Plastic Quad Flat Package (PQFP) with a 3.9 mm footprint. See [Figure 3.10](#) on [page 3-18](#).

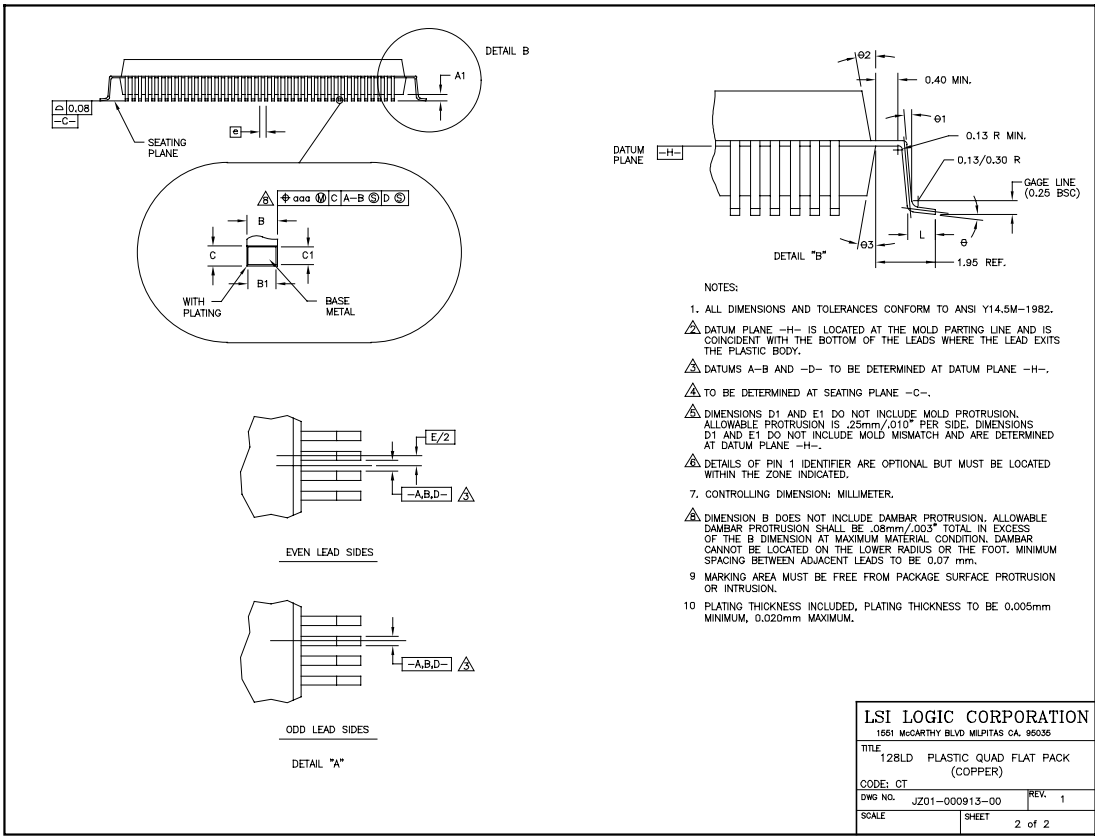
Figure 3.10 LSI53C120 Mechanical Drawing (Sheet 1 of 2)



**Important:** This drawing may not be the latest version. For board layout and manufacturing, obtain the most recent engineering drawings from your LSI Logic marketing representative by requesting the outline drawing for package code CT.



**Figure 3.10 LSI53C120 Mechanical Drawing (Sheet 2 of 2)**



<b>LSI LOGIC CORPORATION</b>	
1561 McCARTHY BLVD MILPITAS CA. 95035	
TITLE	
128LD PLASTIC QUAD FLAT PACK (COPPER)	
CODE: CT	
DWG NO. JZ01-000913-00	REV. 1
SCALE	SHEET 2 of 2

**Important:** This drawing may not be the latest version. For board layout and manufacturing, obtain the most recent engineering drawings from your LSI Logic marketing representative by requesting the outline drawing for package code CT.



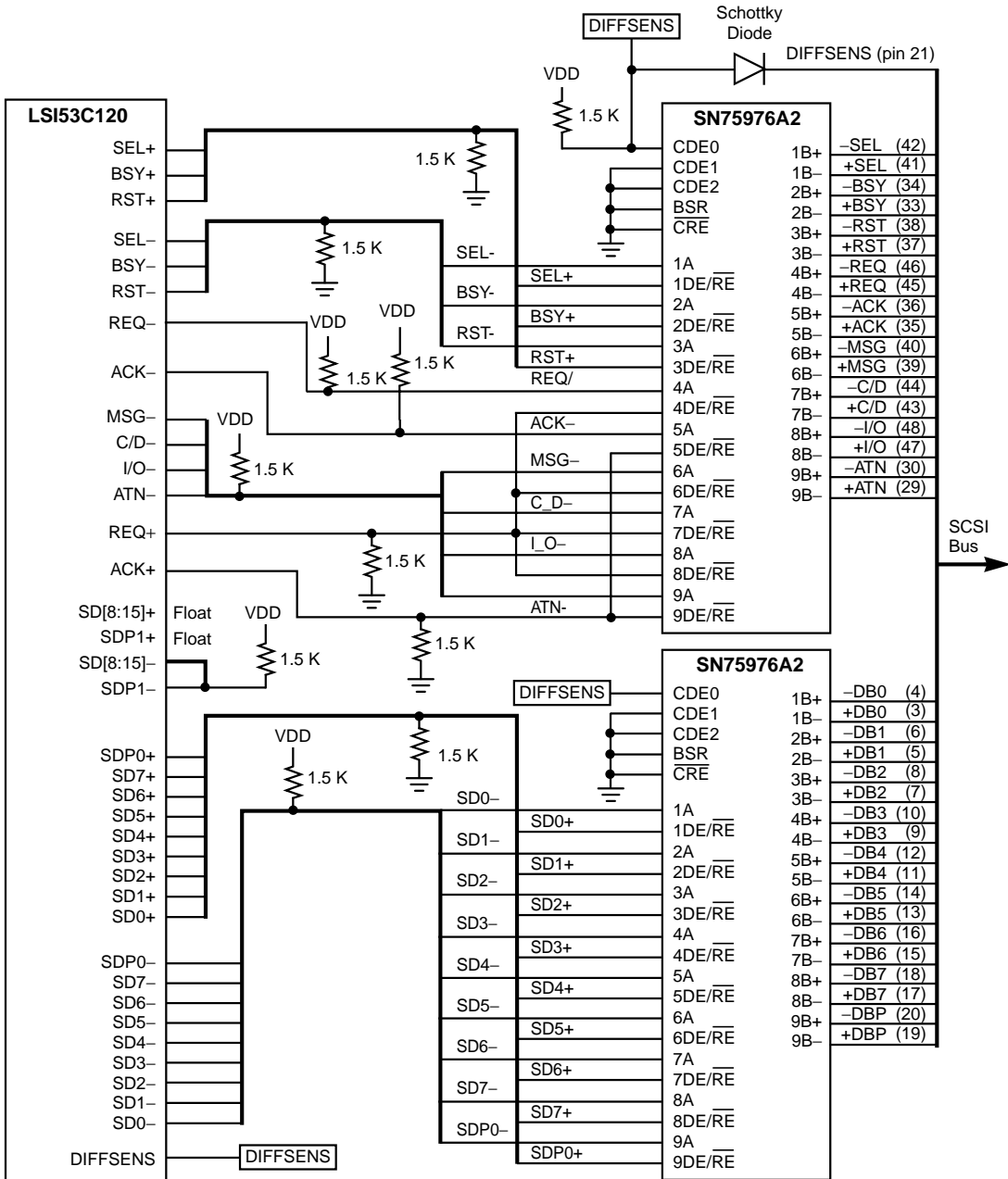
# Appendix A

## Differential Wiring Diagram

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[Figure A.1](#) shows the wiring diagram for Ultra SCSI operation in the differential mode using pull-up resistors.

**Figure A.1 LSI53C120 Differential Wiring Diagram**



# Appendix B

## Glossary

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<b>ACK/</b>	Acknowledge – Driven by an initiator, ACK/ indicates an acknowledgment for a SCSI data transfer. In the target mode, ACK/ is received as a response to the REQ/ Signal.
<b>ANSI</b>	American National Standards Institute.
<b>Arbitration</b>	The process of selecting one respondent from a collection of several candidates that request service concurrently.
<b>Asserted</b>	A signal is asserted when it is in the state which is indicated by the name of the signal. Opposite of negated or deasserted.
<b>Assertion</b>	The act of driving a signal to the true state.
<b>Asynchronous Transmission</b>	Transmission in which each byte of the information is synchronized individually, through the use of Request (REQ/) and Acknowledge (ACK/) signals.
<b>ATN/</b>	Attention – Driven by an initiator, indicates an attention condition. In the target role, ATN/ is received and is responded to by entering the Message Out Phase.
<b>Autoconfiguration Ports</b>	Three 8-bit ports (Address, Write_Data, and Read_Data) used by software to access the configuration space on each Plug and Play card. The configuration space is implemented as a set of 8-bit registers. These registers are used by the Plug and Play software to issue commands, check status, access the resource data information, and configure the Plug and Play hardware.
<b>Block</b>	A block is the basic 512 byte region of storage into which the storage media is divided. The Logical Block Address protocol uses sequential block addresses to access the media.
<b>BSY/</b>	Busy – Indicates that the SCSI Bus is being used. BSY/ can be driven by both the initiator and the target device.

<b>Bus</b>	A collection of unbroken signal lines that interconnect computer modules. The connections are made by taps on the lines.
<b>C_D/</b>	Control/Data – Driven by a target, indicates Control or Data Information is on the SCSI Bus. This signal is received by the initiator.
<b>Connect</b>	The function that occurs when an initiator selects a target to start an operation, or a target reselects an initiator to continue an operation.
<b>Control Signals</b>	The set of nine lines used to put the SCSI bus into its different phases. The combinations of asserted and negated control signals define the phases.
<b>Controller</b>	A computer module that interprets signals between a host and a peripheral device. Often, the controller is a part of the peripheral device, such as circuitry on a disk drive.
<b>DB0/-DB7/</b>	SCSI Data Bits and Parity Bit – These eight Data Bits (DB0/-DB7/), plus a Parity Bit (DBP/), form the SCSI Bus. DB7/ is the most significant bit and has the highest priority ID during the Arbitration Phase. Data parity is odd. Parity is always generated and optionally checked. Parity is not valid during arbitration.
<b>Deasserted</b>	<p>The act of driving a signal to the false state or allowing the cable terminators to bias the signal to the false state (by placing the driver in the high impedance condition).</p> <p>A signal is deasserted or negated when it is in the state opposite to that which is indicated by the name of the signal. Opposite of asserted.</p>
<b>Device</b>	A single unit on the SCSI bus, identifiable by an SCSI address. It can be a processor unit, a storage unit (such as a disk or tape controller or drive), an output unit (such as a controller or printer), or a communications unit.
<b>Disconnect</b>	The function that occurs when a target releases control of the SCSI bus, allowing the bus to go to the Bus Free phase.
<b>Driver</b>	When used in the context of electrical configuration, “driver” is the circuitry that creates a signal on a line. When used in the context of software, “driver” is the program that translates commands between the initiator and target.

<b>External Configuration</b>	All SCSI peripheral devices are external to the host enclosure.
<b>External Terminator</b>	The terminator that exists on the last peripheral subsystem that terminates the external end of the SCSI bus.
<b>Exit-Point Terminator</b>	A Terminator that may be enabled or disabled which exists at the 50-position high-density connector on hosts that support a mixed configuration (combination of internal and external SCSI peripheral devices).
<b>Free</b>	In the context of Bus Free phase, “free” means that no SCSI device is actively using the SCSI bus and, therefore, the bus is available for use.
<b>Gigabyte</b>	One billion bytes; equal to one thousand megabytes.
<b>High (logical level)</b>	A signal is in the high logic state when it is above approximately 2.5 volts.
<b>Host</b>	A processor, usually consisting of the central processing unit and main memory. Typically, a host communicates with other devices, such as peripherals and other hosts. On the SCSI bus, a host has an SCSI address.
<b>Host Adapter</b>	Circuitry that translates between a processor's internal bus and a different bus, such as SCSI. On the SCSI bus, a host adapter usually acts as an initiator.
<b>Initiator</b>	An SCSI device that requests another SCSI device (a target) to perform an operation. Usually, a host acts as an initiator and a peripheral device acts as a target.
<b>Internal Configuration</b>	All SCSI peripheral devices are internal to the host enclosure.
<b>Internal Terminator</b>	The terminator that exists within the host that terminates the internal end of the SCSI bus.
<b>I/O/</b>	Input/Output – Driven by a target, controls the direction of data transfer on the SCSI Bus. When active, this signal indicates input to the initiator. When inactive, this signal indicates output from the initiator. This signal is also used to distinguish between the Selection and Reselection Phases.

<b>I/O Cycle</b>	An I/O cycle is an Input (I/O Read) operation or Output (I/O Write) operation that accesses the PC Card's I/O address space.
<b>I/O Mapped</b>	A storage location or register is I/O mapped when it is available to be accessed using I/O cycles. The register or storage location might also be accessible using memory cycles, in which case it would also be memory mapped.
<b>IREQ</b>	Interrupt Request – Alerts the host computer of a condition that needs to be serviced. Most of the interrupts are individually maskable. The Interrupt Request signal between a PC Card and a socket when the I/O interface is active.
<b>LBA</b>	Abbreviation for Logical Block Address.
<b>Logical Block Address</b>	A logical block address is a sequential address for accessing the blocks on the storage media. The first block of the media is addressed as block 0 and succeeding blocks are numbered sequentially until the last block is encountered. This is the traditional method for accessing peripherals on an SCSI interface bus.
<b>Logical Unit</b>	The logical representation of a physical or virtual device, addressable through a target. A physical device can have more than one logical unit.
<b>Low (logical level)</b>	A signal is in the low logic level when it is below approximately 0.5 volts.
<b>LSB</b>	Abbreviation for Least Significant Bit or Least Significant Byte. That portion of a number, address or field that occurs right-most when its value is written as a single number in conventional hexadecimal or binary notation. The portion of the number having the least weight in a mathematical calculation using the value.
<b>LUN</b>	Logical Unit Number. Used to identify a logical unit.
<b>Mandatory</b>	A characteristic or feature that must be present in every implementation of the standard.
<b>Memory Cycle</b>	A memory cycle is a memory read (using Output Enable) operation or memory write (using Write Enable / Program) operation that accesses the PC Card's common memory or attribute memory address space.
<b>Memory Interface</b>	The memory interface is the default interface after power-up, PCMCIA Hard Reset, and PCMCIA Soft Reset for both PCMCIA cards and



sockets. This interface supports memory operations as defined in PCMCIA Release 1.0 and later and is used by both Memory Cards and I/O Cards.

<b>Memory Mapped</b>	A storage location or register is memory mapped when it is available to be accessed using memory cycles. The register or storage location might also be accessible using I/O cycles, in which it would also be I/O mapped.
<b>MHz</b>	Megahertz – Measurement in thousands of cycles per second. Used as a measurement of data transfer rate.
<b>microsecond ( s)</b>	One millionth of a second.
<b>MSB</b>	Abbreviation for Most Significant Bit and Most Significant Byte. That portion of a number, address or field that occurs left-most when its value is written as a single number in conventional hexadecimal or binary notation. The portion of the number having the most weight in a mathematical calculation using the value.
<b>MSG/</b>	Message – Driven active by a target during the Message Phase. This signal is received by the initiator.
<b>nanosecond (ns)</b>	One billionth of a second.
<b>Negated</b>	A signal is negated or deasserted when it is in the state opposite to that which is indicated by the name of the signal. Opposite of asserted.
<b>Negation</b>	The act of driving a signal to the false state or allowing the cable terminators to bias the signal to the false state (by placing the driver in the high impedance condition).
<b>ns</b>	nanoseconds.
<b>PC</b>	Abbreviation for Personal Computer. Often used to refer to an 80x86 based computer system.
<b>Parity</b>	A method of checking the accuracy of binary numbers. An extra bit, called a parity bit, is added to a number. If even parity is used, the sum of all 1s in the number and its corresponding parity is always even. If odd parity is used, the sum of the 1s and the parity bit is always odd.

<b>Peripheral device</b>	A device that can be attached to an SCSI bus. Typical peripheral devices are disk drives, tape drives, printers, CD ROMs, or communications units.
<b>Phase</b>	One of the eight states to which the SCSI bus can be set. During each phase, different communication tasks can be performed.
<b>Plug and Play (PnP)</b>	Plug and Play is a specification that frees users from locating and setting ID and IRQ switches and jumpers. PnP permits a card to be configured automatically after installation.
<b>Port</b>	A connection into a bus. The SCSI bus allows eight ports.
<b>Priority</b>	The ranking of the devices on the bus during arbitration.
<b>Protocol</b>	A convention for data transmission that encompasses timing control, formatting, and data representation.
<b>Receiver</b>	The circuitry that receives electrical signals on a line.
<b>Reconnect</b>	The function that occurs when a target reselects an initiator to continue an operation after a disconnect.
<b>Release</b>	The act of allowing the cable terminators to bias the signal to the false state (by placing the driver in the high impedance condition).
<b>REQ/</b>	Request – Driven by a target, indicates a request for an SCSI data-transfer handshake. This signal is received by the initiator.
<b>Reselect</b>	A target can disconnect from an initiator in order to perform a time-consuming function, such as a disk seek. After performing the operation, the target can “reselect” the initiator.
<b>RESET</b>	Reset – Clears all internal registers when active. It does not assert the SCSI RST/ signal and therefore does not reset the SCSI bus.
<b>RST</b>	Reset – Indicates an SCSI Bus reset condition.
<b>SCSI Address</b>	The octal representation of the unique address (0-7) assigned to an SCSI device. This address is normally assigned and set in the SCSI device during system installation.
<b>SCSI ID (Identification) or SCSI Device ID</b>	The bit-significant representation of the SCSI address referring to one of the signal lines DB0/ through DB7/.

<b>SCSI</b>	Small Computer System Interface.
<b>SCAM</b>	An acronym for SCSI Configured AutoMagically or SCSI Configured AutoMatically. SCAM is SCSI's new automatic ID assignment protocol. SCAM frees SCSI user's from locating and setting SCSI ID switches and jumpers. SCAM is the key part of Plug and Play SCSI.
<b>SEL/</b>	Select – Used by an initiator to select a target or by a target to reselect an initiator.
<b>Single-ended configuration</b>	An electrical signal configuration that uses a single line for each signal, referenced to a ground path common to the other signal lines. The advantage of a single-ended configuration is that it uses half the pins, chips, and board area that differential configurations require. The main disadvantage of single-ended configurations is that they are vulnerable to common mode noise. Also, cable lengths are limited.
<b>Synchronous transmission</b>	Transmission in which the sending and receiving devices operate continuously at the same frequency and are held in a desired phase relationship by correction devices. For buses, synchronous transmission is a timing protocol that uses a master clock and has a clock period.
<b>Target</b>	An SCSI device that performs an operation requested by an initiator.
<b>Termination</b>	The electrical connection at each end of the SCSI bus, composed of a set of resistors.
<b>s</b>	Microsecond.



# Index

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## Symbols

sB-7

## Numerics

3-state 2-6

3-state leakage 3-9

## A

A\_SACK/ 2-7, 3-4

A\_SATN/ 2-8, 3-4

A\_SBSY/ 2-6, 3-4

A\_SCD/ 2-8, 3-4

A\_SD/(15-0) 3-4

A\_SDP/(1-0) 3-4

A\_SIO/ 3-4

A\_SMSG/ 2-8, 3-4

A\_SREQ/ 2-7, 3-4

A\_SRST/ 2-7, 3-4

A\_SSEL/ 3-4

Absolute Maximum Stress Ratings 3-8

AC characteristics 3-15

ACK 2-7, B-1

Acknowledge 2-3

Acknowledge (ACK) 2-7

Active negation 2-3

ANSI B-1

Application examples 1-4

Arbitration B-1

Asserted B-1

Assertion B-1

Asynchronous 1-3

Asynchronous transmission B-1

ATN B-1

Attention 3-4, 3-5

Attention (ATN) 2-8

## B

B\_ACKDIR 2-8, 3-6

B\_ATNDIR 2-8, 3-6

B\_BSYDIR 2-8, 3-6

B\_CD\_DIR 2-8, 3-6

B\_IO\_DIR 2-8, 3-6

B\_MSGDIR 2-8, 3-6

B\_REQDIR 2-8, 3-6

B\_RSTDIR 2-8, 3-6

B\_SACK/ 2-7, 3-5

B\_SATN/ 2-8, 3-5

B\_SBSY/ 2-6, 3-5

B\_SCD/ 2-8, 3-5

B\_SD/(15-0) 3-5

B\_SDIR(15-0) 3-6

B\_SDIR(15-0, P0, P1) 2-8

B\_SDIRP(1-0) 3-6

B\_SDP/(1-0) 3-5

B\_SELDIR 2-8, 3-6

B\_SIO/ 2-8, 3-5

B\_SMSG/ 2-8, 3-5

B\_SREQ/ 2-7, 3-5

B\_SRST/ 2-7, 3-5

B\_SSEL/ 3-5

Balanced duty cycles 2-3

Bi-directional connections 2-2

Block B-1

BSY B-1

Bus B-2

Bus arbitration 3-4, 3-5

Bus Reset 3-5

Bus timings 2-4

Busy (BSY) 2-6

## C

C\_D B-2

Calibration 2-3

Capacitance 3-10

Card Information Structure B-2

CCS B-2

Chip Reset (RESET/) 2-10

CLOCK 3-7

Clock (CLOCK) 2-11

Clock signal 2-6

Clock Timing 3-15

Configuration 1-5, 1-6

Configurations 1-4

Connect B-2

Control Signals 3-11, B-2

Control/Data (C/D) 2-8

Controller B-2

## D

D0-D7 B-2

Data 2-3, 2-5, 3-5

Data handshake 3-4, 3-5

Data parity bits 3-5

DB0-DB7 B-2

DC Characteristics 3-8

De-asserted B-2

Decoupling capacitor 3-1, 3-3  
Delay settings 2-3  
Device B-2  
DIFF\_MODE 3-7  
Diff\_Mode Control Signal Polarity 2-9  
DIFF\_SENSE 3-7  
Diff\_Sense 3-7  
Diff\_Sense Control Signal Polarity 2-10  
Differential control 2-1  
Differential Direction Controls 2-8  
Differential Mode (Diff\_Mode) 2-9  
Differential Sense (Diff\_Sense) 2-9  
Differential Signals 3-11  
Disconnect B-2  
Double clocking of data 2-3  
Driver B-2  
Driver direction control 3-6

## E

EEPROM B-3  
Electrostatic discharge 3-8  
Enable/disable SCSI transfers 3-7  
ESD 3-8  
External differential transceiver 2-8  
External SCSI bus 1-6

## F

Filter edges 2-7  
Free B-3

## G

Gigabyte B-3  
Glitches 2-3

## H

High (logical level) B-3  
Host B-3  
Host Adapter B-3  
Hysteresis 2-5

## I

I/O B-3  
I/O Cycle B-4  
I/O Mapped B-4  
Identification B-6  
Initiator B-3  
Input and Output Timings 3-16  
Input capacitance of I/O pads 3-10  
Input capacitance of input pads 3-10  
Input high voltage 3-9  
Input low voltage 3-9  
Input Signals 3-10  
Input Voltage 3-8  
Input/Output (I/O) 2-8  
Internal SCSI bus 1-6  
Internal split ground system 3-1  
IREQ B-4

## L

Latch-up current 3-8  
LBA B-4  
Leading edge filter 2-7  
Leading edge filtered 2-6  
Load bus 2-2  
Load bus 2-5  
Logical Block Address B-4  
Logical Unit B-4  
Low (logical level) B-4  
LSB B-4  
LUN B-4

## M

Mandatory B-4  
Master reset 3-7  
Memory Cycle B-4  
Memory Interface B-4  
Memory Mapped B-5  
Message (MSG) 2-8  
MHz B-5  
microsecond B-5  
MSB B-5  
MSG B-5

## N

nanosecond B-5  
Negated B-5  
Negation B-5  
ns B-5

## O

Operating Conditions 3-9  
Operating free air 3-9  
Output high voltage 3-9  
Output low voltage 3-9

## P

Parallel function 2-7  
Parity 2-3, 2-5, B-5  
PC B-5  
Peripheral device B-6  
Phase B-6  
Phase line 3-4, 3-5  
Plastic Quad Flat Pack (PQFP) 3-1, 3-4, 3-5, 3-6  
Port B-6  
Power On Reset (POR) 2-10  
Power-down 2-3  
Power-up 2-3  
Precision delay control 2-1  
Precision delay control block 2-3  
Precision delay elements 2-3  
Priority B-6  
Protocol B-6  
Pull-down 2-6, 2-8  
Pull-up 2-6, 2-8  
Pulse width 2-7

## R

- RC-type input filters 2-3
- Receiver B-6
- Receiver latch 2-6
- Reconnect B-6
- Recovery 2-8
- Release B-6
- Reliability issue 2-3
- REQ 2-7, B-6
- Request 2-3
- Request (REQ) 2-7
- Reselect B-6
- Reserved B-6
- RESET 2-10, B-6
- Reset (RST) 2-7
- RESET/ 3-7
- RESET/ Control Signal Polarity 2-10
- Re-timing 2-7
- Re-timing circuit 2-1
- Re-timing logic block 2-3
- RST B-6

## S

- Scalable device connectivity 1-4
- SCAM support 2-9
- SCSI B-7
  - TolerANT technology 2-3
- SCSI A Signal Description 3-4
- SCSI Address B-6
- SCSI A-side 1-4, 2-4
- SCSI B-side 1-4, 2-4
- SCSI bus disable mode 1-3, 1-4
- SCSI bus electrical isolation 1-3, 1-6
- SCSI bus protocol 2-4, 2-9
- SCSI Device ID B-6
- SCSI I/O logic 2-8
- SCSI ID 1-3, B-6
- SCSI Interface Timings 3-16
- SCSI phases 2-3
- SCSI Signals 3-10
- SEL B-7
- Signal groupings 2-4
- Signal skew 2-2
- Single-ended configuration B-7
- Single-ended control blocks 2-1, 2-2
- Single-ended to differential 1-3, 1-5, 2-4
- Single-ended to single-ended 1-3, 1-5, 2-2
- Software 1-3, 2-1
- Source bus 2-2, 2-5
- State 2-8
- State machines 2-7
- State-machine control 2-1
- State-machine controls 2-3, 2-4
- Storage temperature 3-8
- Supply voltage 3-8
- SYM53C120 Pin Diagram 3-1
- SYM53C120 SCSI Buddy 1-1
- Synchronous 1-3
- Synchronous transmission B-7

## T

- Target B-7

- Temperature 2-3
- Termination B-7
- Thermal resistance 3-9
- TolerANT receiver technology 2-3
- TolerANT SCSI 2-3
- TolerANT Technology 2-3
  - Benefits 2-3
  - Electrical characteristics 3-12
- TolerANT® Drivers and Receivers 2-1, 2-3
- TolerANT® technology 2-3
- Typical applications 1-4

## U

- Ultra SCSI bus 1-4

## V

- VDD\_CORE 3-7
- VDD\_IO 3-7
- VDD-SCSI 3-7
- Vendor unique B-7
- Voltage 2-3
- VSS\_CORE 3-7
- VSS\_IO 3-7
- VSS-SCSI 3-7

## W

- Warm Start Enable and Transfer Active (WS\_ENABLE and XFER\_ACTIVE) 2-10
- Wide Ultra SCSI 1-3, 2-2
- WS\_ENABLE 3-7
- WS\_ENABLE Signal Polarity 2-11

## X

- XFER\_ACTIVE 3-7
- XFER\_ACTIVE Signal Polarity 2-11





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